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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	40MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	13
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	ОТР
EEPROM Size	-
RAM Size	96 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	18-SOIC (0.295", 7.50mm Width)
Supplier Device Package	18-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c621a-40-so

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC16C62X family can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC16C62X uses a Harvard architecture, in which, program and data are accessed from separate memories using separate busses. This improves bandwidth over traditional von Neumann architecture, where program and data are fetched from the same memory. Separating program and data memory further allows instructions to be sized differently than 8-bit wide data word. Instruction opcodes are 14-bits wide making it possible to have all single word instructions. A 14-bit wide program memory access bus fetches a 14-bit instruction in a single cycle. A two-stage pipeline overlaps fetch and execution of instructions. Consequently, all instructions (35) execute in a single cycle (200 ns @ 20 MHz) except for program branches.

The PIC16C620(A) and PIC16CR620A address 512 x 14 on-chip program memory. The PIC16C621(A) addresses 1K x 14 program memory. The PIC16C622(A) addresses 2K x 14 program memory. All program memory is internal.

The PIC16C62X can directly or indirectly address its register files or data memory. All special function registers including the program counter are mapped in the data memory. The PIC16C62X has an orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any Addressing mode. This symmetrical nature and lack of 'special optimal situations' make programming with the PIC16C62X simple yet efficient. In addition, the learning curve is reduced significantly.

The PIC16C62X devices contain an 8-bit ALU and working register. The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between data in the working register and any register file.

The ALU is 8-bits wide and capable of addition, subtraction, shift and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature. In two-operand instructions, typically one operand is the working register (W register). The other operand is a file register or an immediate constant. In single operand instructions, the operand is either the W register or a file register.

The W register is an 8-bit working register used for ALU operations. It is not an addressable register.

Depending on the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. The C and DC bits operate as a Borrow and Digit Borrow out bit, respectively, bit in subtraction. See the SUBLW and SUBWF instructions for examples.

A simplified block diagram is shown in Figure 3-1, with a description of the device pins in Table 3-1.

4.2.2.2 OPTION Register

The OPTION register is a readable and writable register, which contains various control bits to configure the TMR0/WDT prescaler, the external RB0/INT interrupt, TMR0 and the weak pull-ups on PORTB.

Note: To achieve a 1:1 prescaler assignment for TMR0, assign the prescaler to the WDT (PSA = 1).

REGISTER 4-2: OPTION REGISTER (ADDRESS 81H)

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
RBPU	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0
bit 7							bit 0

bit 7 RBPU: PORTB Pull-up Enable bit

1 = PORTB pull-ups are disabled

0 = PORTB pull-ups are enabled by individual port latch values

bit 6 INTEDG: Interrupt Edge Select bit

1 = Interrupt on rising edge of RB0/INT pin

0 = Interrupt on falling edge of RB0/INT pin

bit 5 **T0CS**: TMR0 Clock Source Select bit

1 = Transition on RA4/T0CKI pin

0 = Internal instruction cycle clock (CLKOUT)

bit 4 T0SE: TMR0 Source Edge Select bit

1 = Increment on high-to-low transition on RA4/T0CKI pin

0 = Increment on low-to-high transition on RA4/T0CKI pin

bit 3 **PSA**: Prescaler Assignment bit

1 = Prescaler is assigned to the WDT

0 = Prescaler is assigned to the Timer0 module

bit 2-0 **PS<2:0>**: Prescaler Rate Select bits

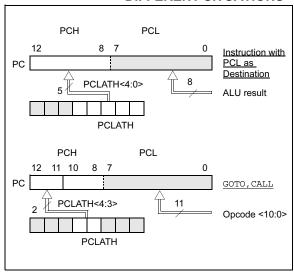
Bit Value	e TMR0 Rate	WDT Rate
000	1:2	1:1
001	1:4	1:2
010	1:8	1:4
011	1 : 16	1:8
100	1:32	1:16
101	1:64	1:32
110	1 : 128	1:64
111	1:256	1 : 128

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR	'1' = Rit is set	'0' = Rit is cleared $x = Rit$ is unknown	

4.3 PCL and PCLATH

The program counter (PC) is 13-bits wide. The low byte comes from the PCL register, which is a readable and writable register. The high byte (PC<12:8>) is not directly readable or writable and comes from PCLATH. On any RESET, the PC is cleared. Figure 4-8 shows the two situations for the loading of the PC. The upper example in the figure shows how the PC is loaded on a write to PCL (PCLATH<4:0> \rightarrow PCH). The lower example in the figure shows how the PC is loaded during a CALL or GOTO instruction (PCLATH<4:3> \rightarrow PCH).

FIGURE 4-8: LOADING OF PC IN DIFFERENT SITUATIONS



4.3.1 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter (ADDWF PCL). When doing a table read using a computed GOTO method, care should be exercised if the table location crosses a PCL memory boundary (each 256 byte block). Refer to the application note, "Implementing a Table Read" (AN556).

4.3.2 STACK

The PIC16C62X family has an 8-level deep x 13-bit wide hardware stack (Figure 4-2 and Figure 4-3). The stack space is not part of either program or data space and the stack pointer is not readable or writable. The PC is PUSHed onto the stack when a CALL instruction is executed or an interrupt causes a branch. The stack is POPed in the event of a RETURN, RETLW or a RETFIE instruction execution. PCLATH is not affected by a PUSH or POP operation.

The stack operates as a circular buffer. This means that after the stack has been PUSHed eight times, the ninth push overwrites the value that was stored from the first push. The tenth push overwrites the second push (and so on).

- Note 1: There are no STATUS bits to indicate stack overflow or stack underflow conditions.
 - 2: There are no instructions/mnemonics called PUSH or POP. These are actions that occur from the execution of the CALL, RETURN, RETLW and RETFIE instructions, or the vectoring to an interrupt address.

6.3.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control (i.e., it can be changed "on-the-fly" during program execution). To avoid an unintended device RESET, the following instruction sequence (Example 6-1) must be executed when changing the prescaler assignment from Timer0 to WDT.)

EXAMPLE 6-1: CHANGING PRESCALER (TIMER0→WDT)

	•	,
1.BCF	STATUS, RPO	;Skip if already in ;Bank 0
2.CLRWDT		;Clear WDT
3.CLRF	TMR0	;Clear TMR0 & Prescaler
4.BSF	STATUS, RPO	;Bank 1
5.MOVLW	'00101111'b;	;These 3 lines (5, 6, 7)
6.MOVWF	OPTION	<pre>;are required only if ;desired PS<2:0> are</pre>
7.CLRWDT		;000 or 001
8.MOVLW	'00101xxx'b	;Set Postscaler to
9.MOVWF	OPTION	;desired WDT rate
10.BCF	STATUS, RPO	;Return to Bank 0

To change prescaler from the WDT to the TMR0 module, use the sequence shown in Example 6-2. This precaution must be taken even if the WDT is disabled.

EXAMPLE 6-2: CHANGING PRESCALER (WDT→TIMER0)

CLRWDT		;Clear WDT and ;prescaler
BSF	STATUS, RPO	,prescarer
MOVLW	b'xxxx0xxx'	;Select TMR0, new ;prescale value and ;clock source
MOVWF BCF	OPTION_REG STATUS, RPO	·

TABLE 6-1: REGISTERS ASSOCIATED WITH TIMERO

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on All Other RESETS
01h	TMR0	Timer0 ı	ner0 module register							xxxx xxxx	uuuu uuuu
0Bh/8Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
81h	OPTION	RBPU	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
85h	TRISA	_	_	_	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	1 1111	1 1111

Legend: — = Unimplemented locations, read as '0', u = unchanged, x = unknown

Note: Shaded bits are not used by TMR0 module.

8.0 VOLTAGE REFERENCE MODULE

The Voltage Reference is a 16-tap resistor ladder network that provides a selectable voltage reference. The resistor ladder is segmented to provide two ranges of VREF values and has a power-down function to conserve power when the reference is not being used. The VRCON register controls the operation of the reference as shown in Register 8-1. The block diagram is given in Figure 8-1.

8.1 Configuring the Voltage Reference

The Voltage Reference can output 16 distinct voltage levels for each range. The equations used to calculate the output of the Voltage Reference are as follows:

if
$$VRR = 0$$
: $VREF = (VDD x 1/4) + (VR < 3:0 > /32) x VDD$

The setting time of the Voltage Reference must be considered when changing the VREF output (Table 12-1). Example 8-1 shows an example of how to configure the Voltage Reference for an output voltage of 1.25V with VDD = 5.0V.

REGISTER 8-1: VRCON REGISTER(ADDRESS 9Fh)

R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
VREN	VROE	VRR	_	VR3	VR2	VR1	VR0
bit 7							bit 0

bit 7 VREF Enable

1 = VREF circuit powered on

0 = VREF circuit powered down, no IDD drain

bit 6 **VROE:** VREF Output Enable

1 = VREF is output on RA2 pin

0 = VREF is disconnected from RA2 pin

bit 5 VRR: VREF Range selection

1 = Low Range

0 = High Range

bit 4 Unimplemented: Read as '0'

bit 3-0 **VR<3:0>**: VREF value selection $0 \le VR$ [3:0] ≤ 15

when VRR = 1: VREF = (VR<3:0>/ 24) * VDD

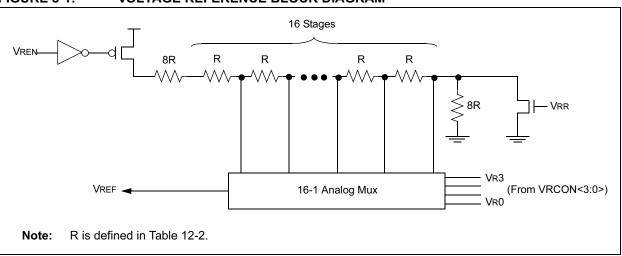
when VRR = 0: VREF = 1/4 * VDD + (VR<3:0>/ 32) * VDD

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

- n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

FIGURE 8-1: VOLTAGE REFERENCE BLOCK DIAGRAM



10.1 Instruction Descriptions

ADDLW	Add Literal and W
Syntax:	[label] ADDLW k
Operands:	$0 \leq k \leq 255$
Operation:	$(W) + k \rightarrow (W)$
Status Affected:	C, DC, Z
Encoding:	11 111x kkkk kkkk
Description:	The contents of the W register are added to the eight bit literal 'k' and the result is placed in the W register.
Words:	1
Cycles:	1
Example	ADDLW 0x15
	Before Instruction W = 0x10 After Instruction W = 0x25
	••• ••••

ADDWF	Add W and f
Syntax:	[label] ADDWF f,d
Operands:	$\begin{aligned} 0 &\leq f \leq 127 \\ d &\in [0,1] \end{aligned}$
Operation:	$(W) + (f) \to (dest)$
Status Affected:	C, DC, Z
Encoding:	00 0111 dfff ffff
Description:	Add the contents of the W register with register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.
Words:	1
Cycles:	1
Example	ADDWF FSR, 0
	Before Instruction

ANDLW	AND Literal with W						
Syntax:	[label] ANDLW k						
Operands:	$0 \leq k \leq 255$						
Operation:	(W) .AND. $(k) \rightarrow (W)$						
Status Affected:	Z						
Encoding:	11 1001 kkkk kkkk						
Description:	The contents of W register are AND'ed with the eight bit literal 'k'. The result is placed in the W register.						
Words:	1						
Cycles:	1						
Example	ANDLW 0x5F						
	Before Instruction W = 0xA3 After Instruction W = 0x03						

ANDWF	AND W with f					
Syntax:	[label] ANDWF f,d					
Operands:	$0 \le f \le 127$ $d \in [0,1]$					
Operation:	(W) .AND. (f) \rightarrow (dest)					
Status Affected:	Z					
Encoding:	00 0101 dfff ffff					
Description:	AND the W register with register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.					
Words:	1					
Cycles:	1					
Example	ANDWF FSR, 1					
	Before Instruction W = 0x17 FSR = 0xC2 After Instruction W = 0x17 FSR = 0x02					

MOVF	Move f							
Syntax:	[label] MOVF f,d							
Operands:	$0 \le f \le 127$ $d \in [0,1]$							
Operation:	$(f) \rightarrow (dest)$							
Status Affected:	Z							
Encoding:	00 1000 dfff ffff							
Description:	The contents of register f is moved to a destination dependent upon the status of d. If d = 0, destination is W register. If d = 1, the destination is file register f itself. d = 1 is useful to test a file register since status flag Z is affected.							
Words:	1							
Cycles:	1							
Example	MOVF FSR, 0							
	After Instruction W = value in FSR register Z = 1							

Move W to f							
[label] MOVWF f							
$0 \le f \le 12$	27						
$(W) \rightarrow (f)$)						
None							
00	0000	1ff	f	ffff			
Move data from W register to register 'f'.							
1							
1							
MOVWF	OPTION	1					
After Inst	OPTION W ruction OPTION	=	0x4F	:			
	[label] $0 \le f \le 12$ (W) → (f) None 00 Move datister 'f'. 1 MOVWF Before In		[label] MOVWF f f 0 ≤ f ≤ 127 (W) → (f) None	$ [label] MOVWF f $ $0 \le f \le 127 $ $(W) → (f) $ None $00 0000 1fff $ Move data from W register ister 'f'. 1 1 $MOVWF OPTION$ Before Instruction $OPTION = 0xFF $ $W = 0x4F $ After Instruction $OPTION = 0x4F $			

NOP	No Operation							
Syntax:	[label]	NOP						
Operands:	None							
Operation:	No operation							
Status Affected:	None							
Encoding:	00	0000	0xx0	0000				
Description:	No opera	ation.						
Words:	1							
Cycles:	1							
Example	NOP							

OPTION	Load Op	tion Re	gister					
Syntax:	[label] OPTION							
Operands:	None							
Operation:	$(W) \rightarrow O$	PTION						
Status Affected:	None							
Encoding:	00	0000	0110	0010				
Description: Words:	The contelloaded in This instructed comproducts able/writed directly a	the OPT ruction is apatibility Since Cable regis	FION reging supported with PICO PTION is ster, the uncorrected to the properties of	ster. ed for 16C5X s a read-				
Cycles:	1							
Example				411.11				
	To maintain upward compatibility with future PICmicro [®] products, do not use this instruction.							

11.0 DEVELOPMENT SUPPORT

The PICmicro[®] microcontrollers are supported with a full range of hardware and software development tools:

- · Integrated Development Environment
 - MPLAB® IDE Software
- · Assemblers/Compilers/Linkers
 - MPASM™ Assembler
 - MPLAB C17 and MPLAB C18 C Compilers
 - MPLINK[™] Object Linker/ MPLIB[™] Object Librarian
 - MPLAB C30 C Compiler
- MPLAB ASM30 Assembler/Linker/Library
- Simulators
 - MPLAB SIM Software Simulator
 - MPLAB dsPIC30 Software Simulator
- Emulators
 - MPLAB ICE 2000 In-Circuit Emulator
 - MPLAB ICE 4000 In-Circuit Emulator
- · In-Circuit Debugger
 - MPLAB ICD 2
- · Device Programmers
 - PRO MATE® II Universal Device Programmer
 - PICSTART® Plus Development Programmer
- · Low Cost Demonstration Boards
 - PICDEM™ 1 Demonstration Board
 - PICDEM.net™ Demonstration Board
 - PICDEM 2 Plus Demonstration Board
 - PICDEM 3 Demonstration Board
 - PICDEM 4 Demonstration Board
 - PICDEM 17 Demonstration Board
 - PICDEM 18R Demonstration Board
 - PICDEM LIN Demonstration Board
 - PICDEM USB Demonstration Board
- Evaluation Kits
 - KEELOQ®
 - PICDEM MSC
 - microID®
 - CAN
 - PowerSmart®
 - Analog

11.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8/16-bit microcontroller market. The MPLAB IDE is a Windows® based application that contains:

- · An interface to debugging tools
 - simulator
 - programmer (sold separately)
 - emulator (sold separately)
 - in-circuit debugger (sold separately)
- · A full-featured editor with color coded context
- · A multiple project manager
- Customizable data windows with direct edit of contents
- · High level source code debugging
- · Mouse over variable inspection
- · Extensive on-line help

The MPLAB IDE allows you to:

- Edit your source files (either assembly or C)
- One touch assemble (or compile) and download to PICmicro emulator and simulator tools (automatically updates all project information)
- · Debug using:
 - source files (assembly or C)
 - absolute listing file (mixed assembly and C)
 - machine code

MPLAB IDE supports multiple debugging tools in a single development paradigm, from the cost effective simulators, through low cost in-circuit debuggers, to full-featured emulators. This eliminates the learning curve when upgrading to tools with increasing flexibility and power.

11.2 MPASM Assembler

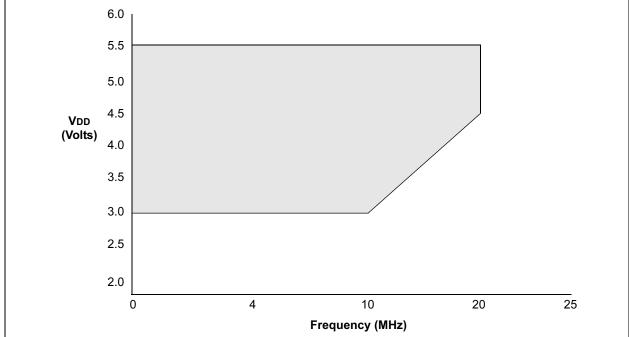
The MPASM assembler is a full-featured, universal macro assembler for all PICmicro MCUs.

The MPASM assembler generates relocatable object files for the MPLINK object linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code and COFF files for debugging.

The MPASM assembler features include:

- · Integration into MPLAB IDE projects
- · User defined macros to streamline assembly code
- Conditional assembly for multi-purpose source files
- Directives that allow complete control over the assembly process

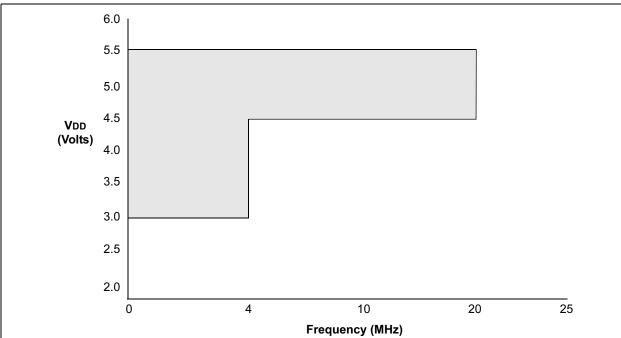
FIGURE 12-3: PIC16C62XA VOLTAGE-FREQUENCY GRAPH, $0^{\circ}C \le TA \le +70^{\circ}C$



Note 1: The shaded region indicates the permissible combinations of voltage and frequency.

2: The maximum rated speed of the part limits the permissible combinations of voltage and frequency. Please reference the Product Identification System section for the maximum rated speed of the parts.

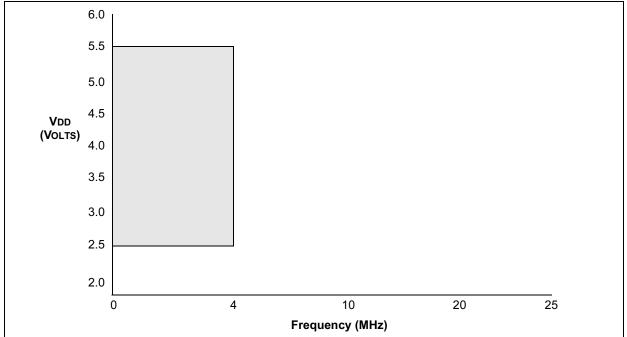
FIGURE 12-4: PIC16C62XA VOLTAGE-FREQUENCY GRAPH, -40°C \leq TA \leq 0°C, +70°C \leq TA \leq +125°C



Note 1: The shaded region indicates the permissible combinations of voltage and frequency.

2: The maximum rated speed of the part limits the permissible combinations of voltage and frequency. Please reference the Product Identification System section for the maximum rated speed of the parts.

FIGURE 12-9: PIC16LCR62XA VOLTAGE-FREQUENCY GRAPH, -40°C ≤ TA ≤ +125°C



Note 1: The shaded region indicates the permissible combinations of voltage and frequency.

2: The maximum rated speed of the part limits the permissible combinations of voltage and frequency. Please reference the Product Identification System section for the maximum rated speed of the parts.

12.2 DC Characteristics: PIC16C62XA-04 (Commercial, Industrial, Extended) PIC16C62XA-20 (Commercial, Industrial, Extended)

PIC16LC62XA-04 (Commercial, Industrial, Extended (CONT.)

PIC16C62XA			Oper	ating te	perati	ng Con	ditions (unless otherwise stated) $10^{\circ}\text{C} \leq \text{TA} \leq +85^{\circ}\text{C}$ for industrial and $10^{\circ}\text{C} \leq \text{TA} \leq +70^{\circ}\text{C}$ for commercial and $10^{\circ}\text{C} \leq \text{TA} \leq +125^{\circ}\text{C}$ for extended ditions (unless otherwise stated) $10^{\circ}\text{C} \leq \text{TA} \leq +85^{\circ}\text{C}$ for industrial and $10^{\circ}\text{C} \leq \text{TA} \leq +70^{\circ}\text{C}$ for commercial and
Param. Sym Characteristic				Тур†	Max		0°C ≤ TA ≤ +125°C for extended Conditions
No.							
D022	ΔIWDT	WDT Current ⁽⁵⁾	_	6.0	10 12	μ Α μ Α	V _{DD} = 4.0V (125°C)
D022A D023	ΔIBOR ΔICOMP	Brown-out Reset Current ⁽⁵⁾ Comparator Current for each Comparator ⁽⁵⁾	_ _	75 30	125 60	μA μA	BOD enabled, VDD = 5.0V VDD = 4.0V
D023A	Δ IVREF	VREF Current ⁽⁵⁾	_	80	135	μА	VDD = 4.0V
D022	ΔIWDT	WDT Current ⁽⁵⁾	_	6.0	10 12	μ Α μ Α	VDD=4.0V (125°C)
D022A	$\Delta IBOR$	Brown-out Reset Current ⁽⁵⁾	_	75	125	μA	BOD enabled, VDD = 5.0V
D023	ΔICOMP	Comparator Current for each Comparator ⁽⁵⁾	_	30	60	μΑ	VDD = 4.0V
D023A	ΔIVREF	VREF Current ⁽⁵⁾	_	80	135	μΑ	VDD = 4.0V
1A	Fosc	LP Oscillator Operating Frequency	0	_	200	kHz	All temperatures
		RC Oscillator Operating Frequency	0	_	4	MHz	All temperatures
		XT Oscillator Operating Frequency HS Oscillator Operating Frequency	0	_	4 20	MHz MHz	All temperatures All temperatures
1A	Fosc	LP Oscillator Operating Frequency	0	_	200	kHz	All temperatures
		RC Oscillator Operating Frequency XT Oscillator Operating Frequency HS Oscillator Operating Frequency	0 0 0	_ _ _	4 4 20	MHz MHz MHz	All temperatures All temperatures All temperatures

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption

The test conditions for all IDD measurements in Active Operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tri-stated, pulled to VDD,

MCLR = VDD; WDT enabled/disabled as specified.

- 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD or Vss.
- 4: For RC osc configuration, current through REXT is not included. The current through the resistor can be estimated by the formula: Ir = VDD/2REXT (mA) with REXT in kΩ.
- 5: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.
- 6: Commercial temperature range only.

12.4 DC Characteristics: PIC16C62X/C62XA/CR62XA (Commercial, Industrial, Extended) PIC16LC62X/LC62XA/LCR62XA (Commercial, Industrial, Extended)

			Standard Operating Conditions (unless otherwise stated)							
PIC16C	PIC16C62X/C62XA/CR62XA		Operatir	ng tem	oerature		\leq Ta \leq +85°C for industrial and			
1 10 100	1 10 10002/4 002/4 4 01(02/4)					0°C	≤ Ta ≤ +70°C for commercial and			
						-40°C	≤ TA ≤ +125°C for extended			
				Standard Operating Conditions (unless otherwise stated)						
PIC16L	C62X/I	LC62XA/LCR62XA	Operation	ng tem	perature		≤ TA ≤ +85°C for industrial and			
	00_,0					0°C	≤ TA ≤ +70°C for commercial and			
	ı			1	ı	-40°C	≤ Ta ≤ +125°C for extended			
Param. No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions			
	VIL	Input Low Voltage								
		I/O ports								
D030		with TTL buffer	Vss	_	0.8V 0.15 VDD	V	VDD = 4.5V to 5.5V otherwise			
D031		with Schmitt Trigger input	Vss	_	0.2 VDD	V				
D032		MCLR, RA4/T0CKI,OSC1 (in RC mode)	Vss	_	0.2 VDD	V	(Note 1)			
D033		OSC1 (in XT and HS)	Vss	_	0.3 VDD	V				
		OSC1 (in LP)	Vss	_	0.6 VDD- 1.0	V				
	VIL	Input Low Voltage								
		I/O ports								
D030		with TTL buffer	Vss	_	0.8V 0.15 VDD	V	VDD = 4.5V to 5.5V otherwise			
D031		with Schmitt Trigger input	Vss	_	0.2 VDD	V				
D032		MCLR, RA4/T0CKI,OSC1 (in RC mode)	Vss	_	0.2 VDD	V	(Note 1)			
D033		OSC1 (in XT and HS)	Vss	_	0.3 VDD	V				
		OSC1 (in LP)	Vss	_	0.6 VDD- 1.0	V				
	VIH	Input High Voltage								
		I/O ports								
D040		with TTL buffer	2.0V 0.25 VDD + 0.8V	_	VDD VDD	٧	VDD = 4.5V to 5.5V otherwise			
D041		with Schmitt Trigger input	0.8 VDD	_	VDD					
D042		MCLR RA4/T0CKI	0.8 VDD	_	VDD	V				
D043 D043A		OSC1 (XT, HS and LP) OSC1 (in RC mode)	0.7 VDD 0.9 VDD	_	VDD	V	(Note 1)			

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1 pin is a Schmitt Trigger input. It is not recommended that the PIC16C62X(A) be driven with external clock in RC mode.

^{2:} The leakage current on the MCLR pin is strongly dependent on applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

^{3:} Negative current is defined as coming out of the pin.

12.4 DC Characteristics: PIC16C62X/C62XA/CR62XA (Commercial, Industrial, Extended) PIC16LC62X/LC62XA/LCR62XA (Commercial, Industrial, Extended) (CONT.)

PIC16C62X/C62XA/CR62XA			Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \le \text{TA} \le +70^{\circ}\text{C}$ for commercial and $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for extended							
PIC16L0	PIC16LC62X/LC62XA/LCR62XA			Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq \text{Ta} \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq \text{Ta} \leq +70^{\circ}\text{C}$ for commercial and $-40^{\circ}\text{C} \leq \text{Ta} \leq +125^{\circ}\text{C}$ for extended						
Param. No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions			
B040	VIH	Input High Voltage I/O ports	0.01			.,	N 45V4 55V			
D040		with TTL buffer	2.0V 0.25 VDD + 0.8V	_	VDD VDD	V	VDD = 4.5V to 5.5V otherwise			
D041		with Schmitt Trigger input	0.8 VDD	_	VDD					
D042		MCLR RA4/T0CKI	0.8 VDD	_	VDD	V				
D043 D043A		OSC1 (XT, HS and LP) OSC1 (in RC mode)	0.7 VDD 0.9 VDD	_	VDD	V	(Note 1)			
D070	IPURB	PORTB weak pull-up current	50	200	400	μА	VDD = 5.0V, VPIN = VSS			
D070	IPURB	PORTB weak pull-up current	50	200	400	μА	VDD = 5.0V, VPIN = VSS			
	lıL	Input Leakage Current ^(2, 3) I/O ports (Except PORTA)				μА	Vss ≤ VPIN ≤ VDD, pin at hi-impedance			
D060		PORTA			±1.0	μΑ	Vss ≤ VPIN ≤ VDD, pin at hi-impedance			
D061		RA4/T0CKI			±0.5	μΑ	Vss < VPIN < VDD			
D063		OSC1, MCLR	_	_	±1.0 ±5.0	μА	Vss ≤ VPIN ≤ VDD, XT, HS and LP osc configuration			
	lıL	Input Leakage Current ^(2, 3)					3			
		I/O ports (Except PORTA)			±1.0	μА	Vss ≤ VPIN ≤ VDD, pin at hi-impedance			
D060		PORTA	_	_	±0.5	μА	Vss ≤ VPIN ≤ VDD, pin at hi-impedance			
D061		RA4/T0CKI	_	_	±1.0	μА	Vss ≤ VPIN ≤ VDD			
D063		OSC1, MCLR	_	_	±5.0	μА	Vss ≤ VPIN ≤ VDD, XT, HS and LP osc configuration			
	Vol	Output Low Voltage								
D080		I/O ports	_	_	0.6	V	IOL = 8.5 mA, VDD = 4.5V, -40° to +85°C			
			_	_	0.6	V	IOL = 7.0 mA, VDD = 4.5V, +125°C			
D083		OSC2/CLKOUT (RC only)	_	_	0.6	V	IOL = 1.6 mA, VDD = 4.5V, -40° to +85°C			
				_	0.6	V	IOL = 1.2 mA, VDD = 4.5V, +125°C			

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1 pin is a Schmitt Trigger input. It is not recommended that the PIC16C62X(A) be driven with external clock in RC mode.

^{2:} The leakage current on the MCLR pin is strongly dependent on applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

^{3:} Negative current is defined as coming out of the pin.

TABLE 12-1: COMPARATOR SPECIFICATIONS

Operating Conditions: VDD range as described in Table 12-1, -40°C<TA<+125°C. Current consumption is specified in Table 12-1.

Characteristics	Sym	Min	Тур	Max	Units	Comments
Input offset voltage			± 5.0	± 10	mV	
Input common mode voltage		0		VDD - 1.5	V	
CMRR		+55*			δβ	
Response Time ⁽¹⁾			150*	400* 600*	ns ns	PIC16C62X(A) PIC16LC62X
Comparator mode change to output valid				10*	μS	

^{*} These parameters are characterized but not tested.

Note 1: Response time measured with one comparator input at (VDD - 1.5)/2, while the other input transitions from Vss to VDD.

TABLE 12-2: VOLTAGE REFERENCE SPECIFICATIONS

Operating Conditions:VDD range as described in Table 12-1, -40°C<TA<+125°C. Current consumption is specified in Table 12-1.

Characteristics	Sym	Min	Тур	Max	Units	Comments
Resolution			VDD/24 VDD/32		LSB LSB	Low Range (VRR=1) High Range (VRR=0)
Absolute Accuracy				<u>+</u> 1/4 <u>+</u> 1/2	LSB LSB	Low Range (VRR=1) High Range (VRR=0)
Unit Resistor Value (R)			2K*		Ω	Figure 8-1
Settling Time ⁽¹⁾				10*	μS	

^{*} These parameters are characterized but not tested.

Note 1: Settling time measured while VRR = 1 and VR<3:0> transitions from 0000 to 1111.

PIC16C62X

FIGURE 13-3: IDD VS. VDD (XT OSC 4 MHZ)

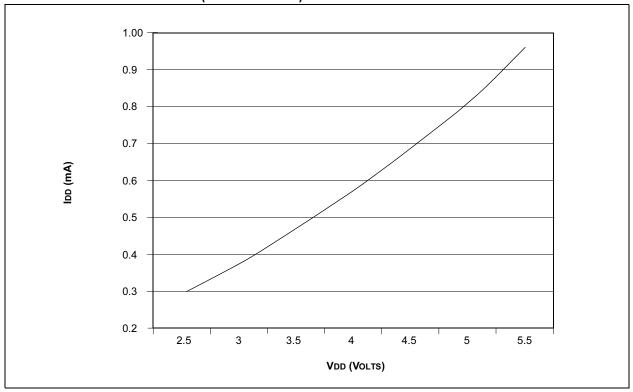
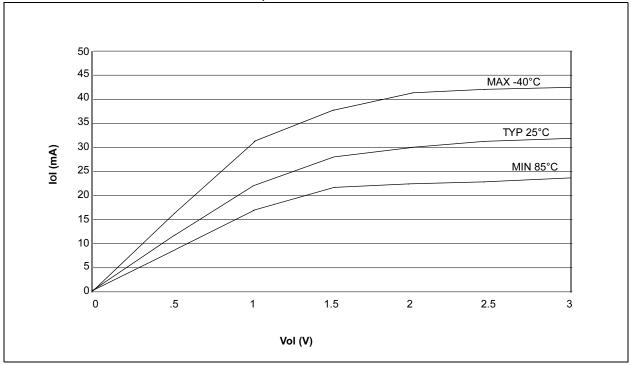
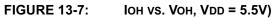
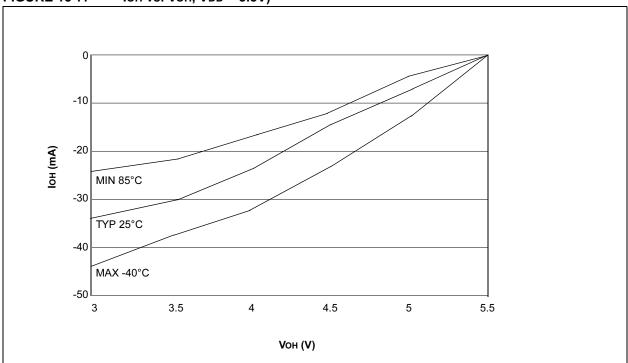


FIGURE 13-4: IOI vs. Vol., VDD = 3.0V)

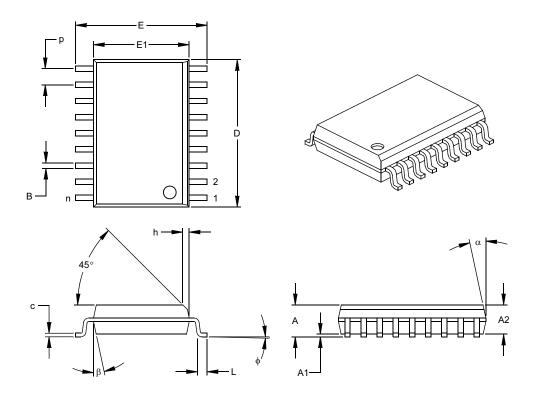


PIC16C62X





18-Lead Plastic Small Outline (SO) - Wide, 300 mil (SOIC)



	Units		INCHES*		MILLIMETERS		
Dimension	Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		18			18	
Pitch	р		.050			1.27	
Overall Height	Α	.093	.099	.104	2.36	2.50	2.64
Molded Package Thickness	A2	.088	.091	.094	2.24	2.31	2.39
Standoff §	A1	.004	.008	.012	0.10	0.20	0.30
Overall Width	Е	.394	.407	.420	10.01	10.34	10.67
Molded Package Width	E1	.291	.295	.299	7.39	7.49	7.59
Overall Length	D	.446	.454	.462	11.33	11.53	11.73
Chamfer Distance	h	.010	.020	.029	0.25	0.50	0.74
Foot Length	L	.016	.033	.050	0.41	0.84	1.27
Foot Angle	ф	0	4	8	0	4	8
Lead Thickness	С	.009	.011	.012	0.23	0.27	0.30
Lead Width	В	.014	.017	.020	0.36	0.42	0.51
Mold Draft Angle Top	α	0	12	15	0	12	15
Mold Draft Angle Bottom	β	0	12	15	0	12	15

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed

.010" (0.254mm) per side. JEDEC Equivalent: MS-013

Drawing No. C04-051

^{*} Controlling Parameter § Significant Characteristic

APPENDIX A: ENHANCEMENTS

The following are the list of enhancements over the PIC16C5X microcontroller family:

- Instruction word length is increased to 14 bits.
 This allows larger page sizes both in program memory (4K now as opposed to 512 before) and register file (up to 128 bytes now versus 32 bytes before).
- A PC high latch register (PCLATH) is added to handle program memory paging. PA2, PA1, PA0 bits are removed from STATUS register.
- Data memory paging is slightly redefined. STATUS register is modified.
- 4. Four new instructions have been added: RETURN, RETFIE, ADDLW, and SUBLW.

 Two instructions TRIS and OPTION are being phased out, although they are kept for compatibility with PIC16C5X.
- OPTION and TRIS registers are made addressable.
- Interrupt capability is added. Interrupt vector is at 0004h.
- 7. Stack size is increased to 8 deep.
- 8. RESET vector is changed to 0000h.
- RESET of all registers is revisited. Five different RESET (and wake-up) types are recognized. Registers are reset differently.
- Wake-up from SLEEP through interrupt is added.
- 11. Two separate timers, Oscillator Start-up Timer (OST) and Power-up Timer (PWRT) are included for more reliable power-up. These timers are invoked selectively to avoid unnecessary delays on power-up and wake-up.
- 12. PORTB has weak pull-ups and interrupt-onchange feature.
- 13. Timer0 clock input, T0CKI pin is also a port pin (RA4/T0CKI) and has a TRIS bit.
- 14. FSR is made a full 8-bit register.
- "In-circuit programming" is made possible. The user can program PIC16CXX devices using only five pins: VDD, Vss, VPP, RB6 (clock) and RB7 (data in/out).
- PCON STATUS register is added with a Poweron-Reset (POR) STATUS bit and a Brown-out Reset STATUS bit (BOD).
- 17. Code protection scheme is enhanced such that portions of the program memory can be protected, while the remainder is unprotected.
- 18. PORTA inputs are now Schmitt Trigger inputs.
- 19. Brown-out Reset reset has been added.
- Common RAM registers F0h-FFh implemented in bank1.

APPENDIX B: COMPATIBILITY

To convert code written for PIC16C5X to PIC16CXX, the user should take the following steps:

- Remove any program memory page select operations (PA2, PA1, PA0 bits) for CALL, GOTO.
- Revisit any computed jump operations (write to PC or add to PC, etc.) to make sure page bits are set properly under the new scheme.
- Eliminate any data memory page switching. Redefine data variables to reallocate them.
- Verify all writes to STATUS, OPTION, and FSR registers since these have changed.
- 5. Change RESET vector to 0000h.

PIC16C62X

INDEX		1	
A		I/O Ports	
ADDLW Instruction	63	I/O Programming Considerations	30
ADDWF Instruction		ID Locations	60
ANDLW Instruction		INCF Instruction	67
ANDWF Instruction		INCFSZ Instruction	68
Architectural Overview		In-Circuit Serial Programming	
Assembler		Indirect Addressing, INDF and FSR Registers	24
MPASM Assembler	75	Instruction Flow/Pipelining	12
		Instruction Set	
В		ADDLW	63
BCF Instruction	64	ADDWF	63
Block Diagram		ANDLW	63
TIMER0		ANDWF	63
TMR0/WDT PRESCALER		BCF	64
Brown-Out Detect (BOD)		BSF	64
BSF Instruction		BTFSC	
BTFSC Instruction		BTFSS	
BTFSS Instruction	65	CALL	
C		CLRF	
C Compilers		CLRW	
MPLAB C17	76	CLRWDT	
MPLAB C18	76	COMF	
MPLAB C30	76	DECF	
CALL Instruction	65	DECFSZ	
Clocking Scheme/Instruction Cycle	12	GOTO	
CLRF Instruction	65	INCF	
CLRW Instruction	66	INCFSZIORLW	
CLRWDT Instruction	66	IORWF	
Code Protection	60	MOVF	
COMF Instruction		MOVF	
Comparator Configuration		MOVWF	
Comparator Interrupts	41	NOP	
Comparator Module		OPTION	
Comparator Operation		RETFIE	
Comparator Reference		RETLW	
Configuration Bits		RETURN	
Configuring the Voltage Reference		RLF	
Crystal Operation	47	RRF	71
D		SLEEP	71
Data Memory Organization	14	SUBLW	72
DC Characteristics	. 87, 101	SUBWF	72
PIC16C717/770/77188, 89, 90, 91, 9	6, 97, 98	SWAPF	73
DECF Instruction	66	TRIS	73
DECFSZ Instruction	67	XORLW	73
Demonstration Boards		XORWF	73
PICDEM 1	78	Instruction Set Summary	
PICDEM 17		INT Interrupt	
PICDEM 18R PIC18C601/801		INTCON Register	
PICDEM 2 Plus		Interrupts	55
PICDEM 3 PIC16C92X		IORLW Instruction	
PICDEM 4		IORWF Instruction	68
PICDEM LIN PIC16C43X		M	
PICDEM USB PIC16C7X5		MOVF Instruction	69
PICDEM.net Internet/Ethernet		MOVLW Instruction	
Development Support	/5	MOVWF Instruction	
E		MPLAB ASM30 Assembler, Linker, Librarian	
Errata	3	MPLAB ICD 2 In-Circuit Debugger	
Evaluation and Programming Tools	79	MPLAB ICE 2000 High Performance Universal	
External Crystal Oscillator Circuit		In-Circuit Emulator	77
G		MPLAB ICE 4000 High Performance Universal	•
General purpose Register File	1/	In-Circuit Emulator	77
GOTO Instruction		MPLAB Integrated Development Environment Softwa	
OO TO HISH UCHOIT	01	MPLINK Object Linker/MPLIB Object Librarian	76



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Corporate Office

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Atlanta

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Boston

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Tel: 978-692-3848 Fax: 978-692-3821

Chicago

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Dallas

4570 Westgrove Drive, Suite 160 Addison, TX 75001

Tel: 972-818-7423 Fax: 972-818-2924

Tri-Atria Office Building 32255 Northwestern Highway, Suite 190 Farmington Hills, MI 48334 Tel: 248-538-2250 Fax: 248-538-2260

2767 S. Albright Road Kokomo, Indiana 46902 Tel: 765-864-8360 Fax: 765-864-8387

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Phoenix

2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7966 Fax: 480-792-4338

San Jose

Microchip Technology Inc. 2107 North First Street, Suite 590 San Jose, CA 95131 Tel: 408-436-7950 Fax: 408-436-7955

Toronto

6285 Northam Drive, Suite 108 Mississauga, Ontario L4V 1X5, Canada Tel: 905-673-0699 Fax: 905-673-6509

ASIA/PACIFIC

Australia

Microchip Technology Australia Pty Ltd Marketing Support Division Suite 22, 41 Rawson Street Epping 2121, NSW Australia

Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing

Microchip Technology Consulting (Shanghai)
Co., Ltd., Beijing Liaison Office Unit 915 Bei Hai Wan Tai Bldg.

No. 6 Chaoyangmen Beidajie Beijing, 100027, No. China Tel: 86-10-85282100 Fax: 86-10-85282104

China - Chengdu

Microchip Technology Consulting (Shanghai) Co., Ltd., Chengdu Liaison Office Rm. 2401-2402, 24th Floor, Ming Xing Financial Tower No. 88 TIDU Street Chengdu 610016, China Tel: 86-28-86766200 Fax: 86-28-86766599

China - Fuzhou

Microchip Technology Consulting (Shanghai) Co., Ltd., Fuzhou Liaison Office Unit 28F, World Trade Plaza No. 71 Wusi Road Fuzhou 350001, China Tel: 86-591-7503506 Fax: 86-591-7503521

China - Hong Kong SAR

Microchip Technology Hongkong Ltd. Unit 901-6, Tower 2, Metroplaza 223 Hing Fong Road Kwai Fong, N.T., Hong Kong Tel: 852-2401-1200 Fax: 852-2401-3431

China - Shanghai

Microchip Technology Consulting (Shanghai) Co., Ltd. Room 701, Bldg. B

Far East International Plaza No. 317 Xian Xia Road Shanghai, 200051

Tel: 86-21-6275-5700 Fax: 86-21-6275-5060

China - Shenzhen

Microchip Technology Consulting (Shanghai) Co., Ltd., Shenzhen Liaison Office Rm. 1812, 18/F, Building A, United Plaza No. 5022 Binhe Road, Futian District Shenzhen 518033, China Tel: 86-755-82901380 Fax: 86-755-82966626

China - Qingdao

Rm. B505A, Fullhope Plaza, No. 12 Hong Kong Central Rd. Qingdao 266071, China Tel: 86-532-5027355 Fax: 86-532-5027205

India

Microchip Technology Inc. India Liaison Office Marketing Support Division Divyasree Chambers 1 Floor, Wing A (A3/A4) No. 11, O'Shaugnessey Road Bangalore, 560 025, India Tel: 91-80-2290061 Fax: 91-80-2290062

Japan

Microchip Technology Japan K.K. Benex S-1 6F 3-18-20, Shinyokohama Kohoku-Ku, Yokohama-shi Kanagawa, 222-0033, Japan Tel: 81-45-471- 6166 Fax: 81-45-471-6122

Korea

Microchip Technology Korea 168-1, Youngbo Bldg. 3 Floor Samsung-Dong, Kangnam-Ku Seoul, Korea 135-882 Tel: 82-2-554-7200 Fax: 82-2-558-5934

Singapore

Microchip Technology Singapore Pte Ltd. 200 Middle Road #07-02 Prime Centre Singapore, 188980 Tel: 65-6334-8870 Fax: 65-6334-8850

Taiwan

Microchip Technology (Barbados) Inc., Taiwan Branch 11F-3, No. 207 Tung Hua North Road Taipei, 105, Taiwan Tel: 886-2-2717-7175 Fax: 886-2-2545-0139

EUROPE

Austria

Microchip Technology Austria GmbH Durisolstrasse 2 A-4600 Wels Austria Tel: 43-7242-2244-399 Fax: 43-7242-2244-393

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Germany

Microchip Technology GmbH Steinheilstrasse 10 D-85737 Ismaning, Germany Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Italy

Microchip Technology SRL Via Quasimodo, 12 20025 Legnano (MI)

Milan, Italy
Tel: 39-0331-742611 Fax: 39-0331-466781

United Kingdom

Microchip Ltd 505 Eskdale Road Winnersh Triangle Wokingham Berkshire, England RG41 5TU

Tel: 44 118 921 5869 Fax: 44-118 921-5820

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